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SPECIFICATION FOR TFT MODULE

MODULE No.: AVD-TT101WX-CN-016-A

CUSTOMER APPROVAL:

	SIGNATURE	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

Notes:

- 1. Please contact AVD before assigning your product based on this module specification.
- 2. To improve the quality of product, and this product specification is subject to change without any notice.



REVISION RECORD

Rev No.	Rev date	Contents	Remarks
0	2016-02-19	First release	Preliminary
	<u> </u>		



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Rev No. :O



1. GENERAL INFORMATION

No.	Item	Contents	Unit
1	LCD size	10.1 inch (Diagonal)	1
2	LCD type	TN/Normally white/Transmissive	1
3	Viewing direction(eye)	FREE	/
4	Gray scale inversion direction	FREE	1
5	Resolution(H*V)	1280 *800 Pixels	1
6	Module size (L*W*H)	120.70*75.90*2.95	mm
7	Active area (L*W)	216.96*135.60	mm
8	Pixel pitch (L*W)	0.1695*0.1695	mm
9	Interface type	LVDS interface	1
10	Module power consumption	TBD	W
11	Back light type	LED	/
12	Weight	TBD	g

2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit
Power supply input voltage(TFT Module)	VDD	-0.3	4	V
Backlight current (normal temp.)	ILED	-	225	mA
Operation temperature	Тор	-10	60	°C
Storage temperature	Tst	-20	70	°C
Humidity	RH	-	90%(Max60 °C)	RH

3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Тур.	Max.	Unit	Note	
Power supply input voltage(TFT Module)	VDD	3.0	3.3	3.6	V		
I/O logic voltage	VDDIO	N/A	N/A	N/A	V		
Input voltage 'H' level	VIH	0.7VDD	-	VDD	V		
Input voltage 'L' level	VIL	VSS	-	0.3VDD	V		
Power supply current	IVDD	-	TBD	-	mA		
TFT gate on voltage	VGH	-	N/A	-	V		
TFT gate off voltage	VGL	-	N/A	-	V		
Analog power supply voltage	AVDD	-	N/A	-	V	_	
Differential input common mode voltage	Vcom	-	N/A	-	V		

4. BACKLIGHT CHARACTERISTICS

(at Ta=25°C,RH=60%)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
LED forward voltage	VF	-	12.8	14	V	IF=180mA
LED forward current	IF	-	180	-	mA	
LED power consumption	PLED	-	2.304	-	W	Note1
Number of LED	-		36		PCS	
Connection mode	-	4 in s	eries 9 in p	arallel	1	
LED life-time	-	-	20000	-	Hrs	Note2

Note1 : Calculator value for reference : IF*VF = PLED

Note2: The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =180mA. The LED lifetime could be decreased if operating IF is larger than 180mA.



5. TOUCH PANEL CHARACTERISTICS

(at Ta=25°C)

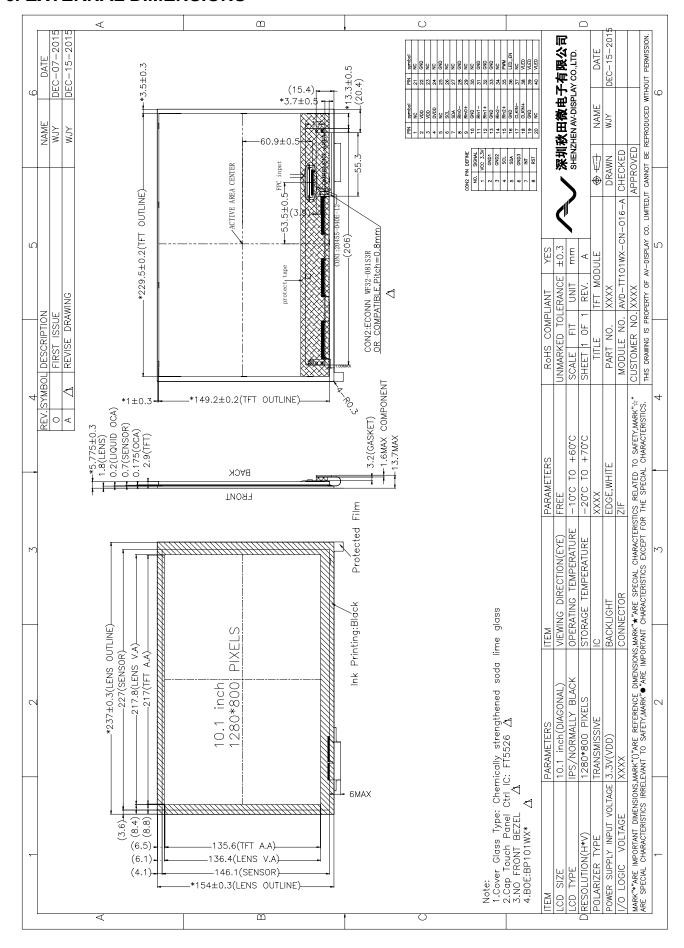
FPC Design	Item	Description	Note
	IC solution on TP Model	FT5526	
	Touch Count Max	5 point	
[1]1COE	Display Resolution*	1280*800	
[√]COF	Interface Type *	I2C	
	I2C Slave Address*	0x70	
	Origin of Coordinate*	Top left corner	
	IC solution on Broad*		
[]COB	Driving Channels		
	Sensing Channels		

Parameter	Min.	Тур.	Max.	Unit
Interface Signal Voltage*	-	3.0	-	V
Power Voltage*	2.8	3.0	3.3	V
Power ripple*	-	-	50	MV

Note1: The detail refer to the Specification For IC.

Note2: "*"means that the item is optional according to the product requirement.

6. EXTERNAL DIMENSIONS



7. ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response time	Tr+ Tf		-	30	-	ms	FIG.1	Note 4
Contrast ratio	Cr	-	600	800	-	-	FIG.2	Note 1
Surface luminance	Lv	θ=0°	220	280	-	cd/m ²	FIG.2	Note 2
Luminance uniformity	Yu	θ=0°	70	-	-	%	FIG.2	Note 3
NTSC	-	θ=0°	-	52	-	%	FIG.2	Note 5
		∅=90°	70	80	-	deg	FIG.3	
Viouring angle	θ	∅=270°	70	80	-	deg	FIG.3	Note 6
Viewing angle		∅=0°	70	80	-	deg	FIG.3	Note 6
		⊘=180°	70	80	-	deg	FIG.3	
	Red x			TBD		-		
	Red y			TBD		-		
	Green x			TBD		-		
CIE (x,y)	Green y	θ=0°	Тур	TBD	Тур	-	FIG.2	Note F
	Blue x	Ø=0° Ta=25°C	-0.04	TBD	+0.04	-	CIE1931	Note 5
	Blue y	10-20 0		TBD		-		
	White x			TBD		-		
	White y			TBD				

Note1.Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= Luminance measured when LCD on the "White" state
Luminance measured when LCD on the "Black" state

Measured at the center area of the LCD

Note2.Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note3. Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

Yu = Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

·u - Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

Note4. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE,the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

Note: For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of response Time

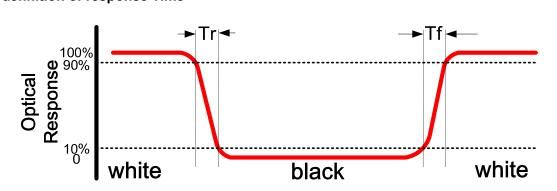


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

Size : S≤5"(see Figure a) A : 5 mm B : 5 mm H,V : Active area

Light spot size \varnothing =5mm(BM-5) or \varnothing =7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure a.

measurement instrument: TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c).

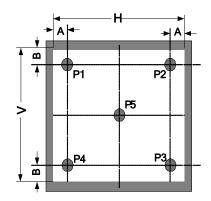


Figure a

Size : 5" < S≤12.3"(see Figure b)

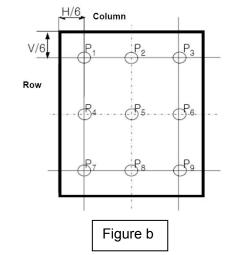
H,V: Active area

Light spot size \varnothing =5mm(BM-5) or \varnothing =7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure b.

measurement instrument: TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c).



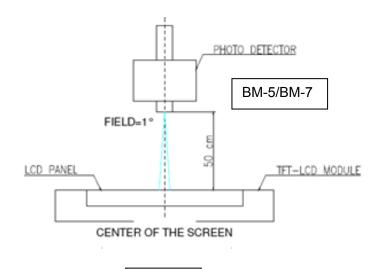
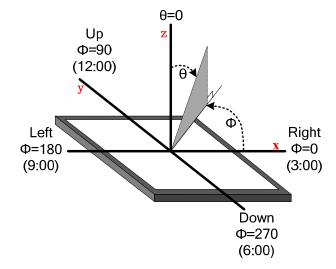


Figure c

FIG.3. The definition of viewing angle





8. INTERFACE DESCRIPTION

TFT Module Interface description

Interface No.	Name	I/O or connect to	Description
1	NC	1	No connection
2	VDD	Р	Power for LCD
3	VDD	Р	Power for LCD
4	DVDD	Р	EDID digital
5	NC	1	No connection
6	SCL	I	EDID clock
7	SDA	I/O	EDID data
8	RIN0-	I	-LVDS differential data input(R0-R5,G0)
9	RIN0-	I	+LVDS differential data input(R0-R5,G0)
10	GND	Р	Power ground
11	RIN1-	I	-LVDS differential data input(G1-R5,B0-B1)
12	RIN1-	I	+LVDS differential data input(G1-R5,B0-B1)
13	GND	Р	Power ground
14	RIN2-	I	-LVDS differential data input(B2-B5,HS,VS,DE)
15	RIN2-	I	+LVDS differential data input(B2-B5,HS,VS,DE)
16	GND	Р	Power ground
17	CLKIN-	I	-LVDS differential clock input
18	CLKIN+	I	+ LVDS differential clock input
19	GND	Р	Power ground
20-21	NC	1	No connection
22	GND	Р	Power ground
23-24	NC	1	No connection
25	GND	Р	Power ground
26-27	NC	1	No connection
28	GND	Р	Power ground
29-30	NC	1	No connection
31-33	GND	Р	Power ground
34	NC	1	No connection
35	PWM	I	LED backlight brightness control
36	LED_EN	I	LED enable pin(+3.3V input)
37	NC	1	No connection
38-40	VLED	Р	LED power supply 5V

CTP interface description

Interface No.	Name	I/O or connect to	Description
1	VCC(3.3V)	Р	Power Supply
2	GND1	Р	Ground
3	GND2	Р	Ground
4	SCL	l	Serial interface clock
5	SDA	I/O	Serial interface date
6	GND3	Р	Ground
7	INT	I	State change interrupt
8	RST	l	Reset low

9. ELECTRICAL CHARACTERISTICS

9.1LVDS mode DC electrical characteristics

Parameter	Symbol		Spec.		Unit	Conditions
Parameter	Symbol	Min.	Тур.	Max.	5	Conditions
Supply Voltage	AVDD	6.5	8.4	13.5	>	For the analog circuit power
Supply Voltage	VCC	2.3	3.3	3.6	>	For the digital circuit power
Input Level of V _{y1} ~ V _{y7}	V_{REF}	0.4AVDD	-	AVDD-0.1	V	Gamma correction voltage
Input Level of V ₇₈ ~ V ₇₁₄	V_{REF}	0.1	-	0.6AVDD	V	Gamma correction voltage
Output Voltage Deviation	Voo	-	-	±20	m۷	-
Voltage Output Offset between Chips	V _{oc}	-	-	±15	m∨	-
Dynamic Range of Output	V_{DR}	0.1	-	AVDD-0.1	>	OUT1~OUT1200/1026
Sinking Current of Outputs	lou	-	-80	-	μA	OUT1~OUT1200/1026; AVDD=10V Vo=0.1V v.s 1.0V
Driving Current of Outputs	Іон	-	80	-	μA	OUT1~OUT1200/1026; AVDD=10V Vo=9.9V v.s 9.0V
Impedance of Gamma Correction	Ri	0.8Rn	1.1Rn	1.4Rn	Ω	Rn: Internal gamma resistor
Analog Stand-by Current	Isc	-	6	-	mA	No load, AVDD=8.4V and all operating is stopped
Analog Operating Current	loc	-	19	-	mA	FcIk=40MHz, FLD=50KHz, AVDD=8.4V, $V_{\gamma 1}$ =8V, $V_{\gamma 14}$ =0.4V under black pattern

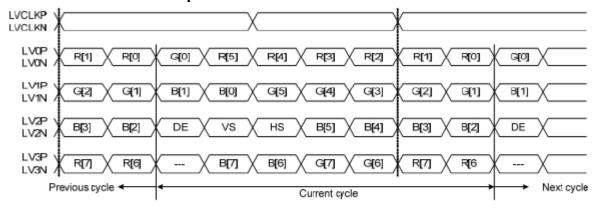
9.2LVDS mode AC electrical characteristics

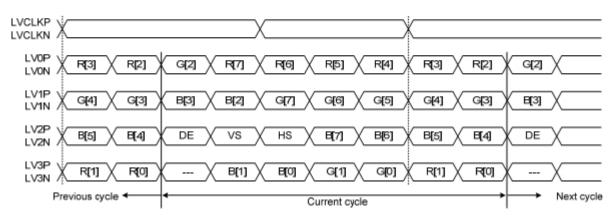
Parameter	Symbol	Spec.			Unit	Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Clock period	tcLK	3.7	-	-	ns	VCC=3.0V to 3.6V
Clock low pulse width	Tolk(L)	1.5	-	-	ns	VCC=3.0V to 3.6V
Clock high pulse width	Tolk(H)	1.5	-	-	ns	VCC=3.0V to 3.6V
Data setup time	T _{seup1}	0.7	-	-	ns	VCC=3.0V to 3.6V
Data hold time	ThoL1	0.7	-	-	ns	VCC=3.0V to 3.6V
CLK,LV[5:0] rising time	trise	-	-	0.1	toux	VCC=3.0V to 3.6V
CLK,LV[5:0] falling time	TFALL	-	-	0.1	toux	VCC=3.0V to 3.6V
Start pulse setup time	tsetup2	1	-	-	ns	VCC=3.0V to 3.6V
Start pulse delay	t _{РLН1}	-	-	10	ns	VCC=3.0V to 3.6V Loading=15pF
time	t _{PHL1}	-	-	10	ns	VCC=3.0V to 3.6V Loading=15pF
Reset(RST) high period	TRESETH	over 3 CLK	-	,	-	-
LD high period	TLD(H)	200	-	-	ns	-
POL to LD setup time	tPOL-LD	5	-	-	ns	POL toggle to TP1 rising
LD to POL hold time	TLD-POL	6	-	-	ns	TP1 falling to POL toggle
Receiver off to LD timing	trec-off	5	-	-	clk	-
LD to reset input time	TLD- RESET	200	-	-	ns	-
Reset low to LD rising time	treset-ld	0	-	-	ns	-
Output stable time	Tst	-	-	6	μs	10% or 90% target voltage CL=120pF, R=4kΩ
Repair output delay time	Tst1	-	-	20	μs	10% or 90% target voltage, CL=190pF, R=2kΩ-



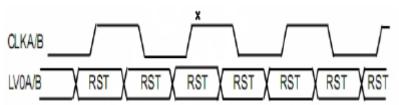
10. DATA INPUT FORMAT

10.1 LVDS mode data input format



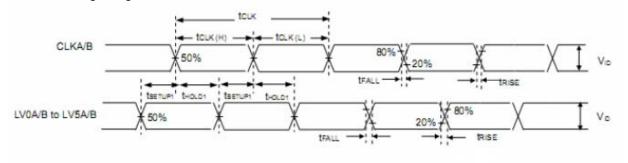


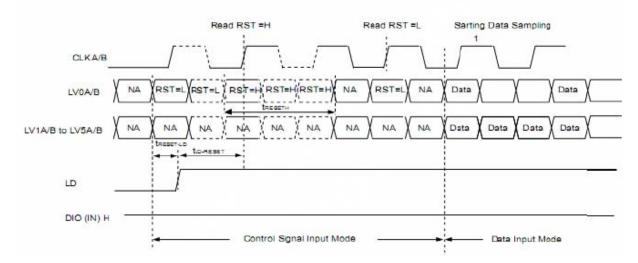
10.2 Control signal input format

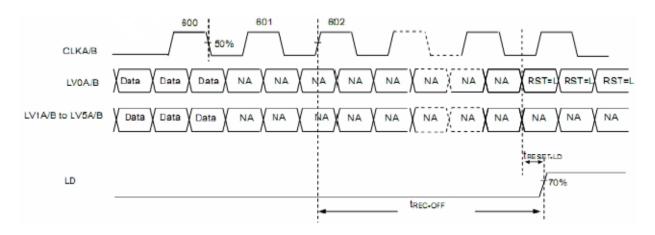


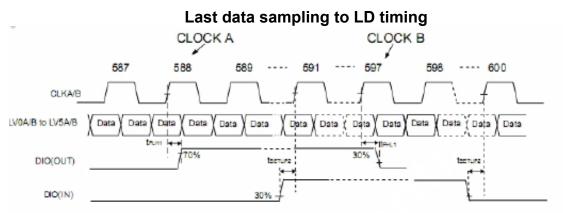
11.TIMING CHARACTERISTICS

11.1 Timing diagram 1 (CHNSL= H, default)





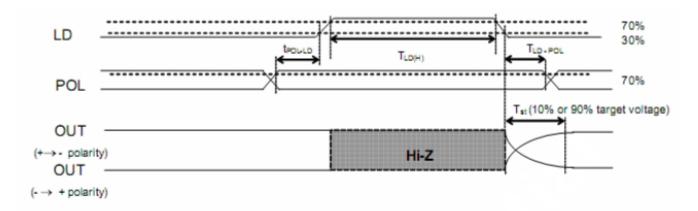


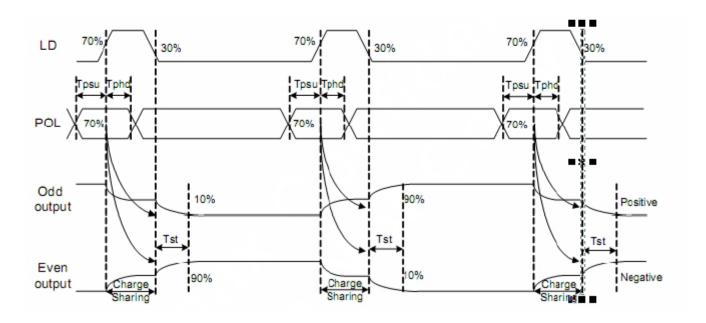


Relationship between DIO(OUT)and DIO(IN) timing



11.2 Timing diagram





12. RELIABILITY TEST CONDITIONS

No.	Test item	Test condition	Inspection after test			
11.1	High temperature storage	80±2°C/240 hours				
11.2	Low temperature storage	-30±2°C/240 hours				
11.3	High temperature operating	70±2°C/120 hours	Inspection after 2~4hours storage at			
11.4	Low temperature operating	-20±2°C/120 hours	room temperature, the sample shall be free			
11.5	Temperature cycle	-20±2°C~25°C~70±2°C*10cycles (30min.) (5min.) (30min.)	from defects : 1.Current changing			
11.6	Damp proof test	50°C*90% RH/120 hours	value before test and after test is 50% larger;			
11.7	Vibration test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	2. Function defect : Non-display,abnormal-di splay,missing lines, Short lines,ITO corrosion; 3. Visual defect : Air			
11.8 Dropping test		Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	bubble in the LCD,Seal leak,Glass crack.			
11.9	ESD test	Voltage : ±8KV R : 330Ω C : 150pF Air discharge, 10time				

Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 3~5pcs.
- 3. For damp proof test, Pure water(Resistance>10M Ω) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6. Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.



12. INSPECTION CRITERION

12.1 Objective

The TFT test criterion are set to formalize TFT quality standards for AVD with reference to those of the customer for inspection, release and acceptance of finished TFT products in order to guarantee the quality of TFT products required by the customer.

12.2. Scope

The criterion is applicable to all the TFT products manufactured by AVD.

12.3. Equipment for Inspection

Electrical tester, electrical testing machines, vernier calipers, microscopes, magnifiers, anti-static wrist straps, finger cots, labels, tri-phase cold and hot shock machine, constant temperature and humidity chamber, backlight table, ovens for high-low temperature experiments, refrigerators, constant voltage power supply (DC), desk Lamps, etc.

12.4. Sampling Plan and Reference Standards

12.4.1 Sampling plan:

Refer to National Standard GB/T 2828.1---2012/ISO2859-1:1999, level II of normal levels:

Major defect: AQL 0.4 Minor defect: AQL 1.0

12.4.2 GB/T 2828.1---2012/ISO2859-1:1999 Sampling check procedure in count

12.4.3 GB/T 18910. Standard for LCM parts

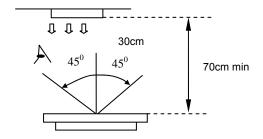
12.4.4 GB/T24213-2008 Basic Environmental Test Procedures for Electrical and Electronic Products

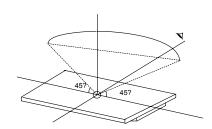
12.4.5 IPC-A-610E Acceptability of Electronic Assemblies

12.5. Inspection Conditions and Inspection Reference

12.5.1 Cosmetic inspection: shall be done normally at 23±5°C of the ambient temperature and 45~75%RH of relative humidity, under the ambient luminance between 500lux~1000lux and at the distance of 30cm apart between the inspector's eyes and the LCD panel and normally in reflected light. For backlight LCM, cosmetic inspection shall be done under the ambient luminance less than 100lux with the backlight on.

12.5.2 The TFT shall be tested at the angle of 45°left and right and 0-45° top and bottom as the following picture showing:





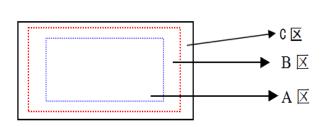
12.5.3 Definition of viewing area(VA)

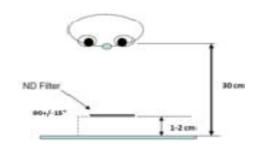
A area : Active area(AA area)
B area : Viewing area(VA area)

C area: Non-viewing area(not viewing after customer assembly)

If there is any appearance viewing defect which do not affect product quality and customer assembly in C area, it's accepted in generally.

The criteria apply to A and B area except chipping and crack.







- 12.5.4 Inspection with naked eyes(exclusive of the inspection of the physical dimensions of defects carried out with magnifiers)
- 12.5.5 ND card use instruction
- 12.5.6 Undefined items or other special items, refer to mutual agreement and limited sample. If criterion does not match product specifications/ technical requirement, both should be subject to special inspection criterion agreed by customer.

12.6. Defects and Acceptance Standards

- 12.6.1 Electrical properties test
- 12.6.1.1 Test voltage(V): Refer to the instruction of testers and the product specification or drawing and the display content and parameters and display effects shall conform to the product specification and drawing.
- 12.6.1.2 Current Consumption(I): Refer to approved product specifications or drawings.

12.6.1.3 Function items(Defect category : MA.)

No.	Defects	Descriptions	Pictures	Inspection method/tools	Defect category
12.6.1.3.1		shows no picture/display in normal connected situation.		Naked eyes/ testers	MA.
12.6.1.3.2	Missing segment	Shows missing lines in normal display		Naked eyes/ testers	MA.
12.6.1.3.3	Sealing Defect	Shows defect in any display around LCD liquid crystal sealant area		Naked eyes/ testers	MA.
12.6.1.3.4	POL angle defect	Not accepted	正常 POL斯反180度后	Naked eyes/ testers	MA.
12.6.1.3.5	Image retention (sticking)	The previous picture stays in the next picture.Disappear time <10s, OK; time>10s, NG		Naked eyes/ testers	MA.
12.6.1.3.6	Flicker	Not accepted		Naked eyes/ testers	MA.
12.6.1.3.7	Display abnormal	Not accepted		Naked eyes/ testers	MA.
12.6.1.3.8	Cross-talk	Refer to limited sample	+	Naked eyes/ limited sample	MA.
12.6.1.3.9	Display dim/bright	Refer to limited sample	1	Naked eyes/ limited sample	MA.
12.6.1.3.10	Contrast	Refer to limited sample	1	Naked eyes/ limited sample	MA.
12.6.1.3.11	Huge current	Out of spec, not accepted	1	Ammeter	MA.



	TP			Naked eyes/	
12.6.1.3.12	function	Not accepted	1	Touch/	MA.
	defect			test program	

12.6.2 LCD dot/line defect

12.6.2.1 LCD pixel dot defect(defect category : MI.)

Item	<u> </u>	Inspection criterio	n
Size	S<5"	5"≤S<10"	10"≤S<15"
Color pixel dot defect(RGB dot)	1	2	2
2 connected bright dot	0	1	1
3 connected bright dot or more	0	0	1
Bright dot quantity	1	2	3
Random dark dot quantity	2	3	4
2 connected dark dot	1	1	2
3 connected dark dot or more	0	0	0
Dark dot quantity	3	4	5
Multi-bright dot		ND 3%hidden, OK	

Remark: 2 bright dots distance DS≥15mm 2 dark dots distance DS≥5mm

- 1) Bright dot: Power on TFT and RGB dot in black display
- 2) Dark dot: Power on TFT and gray or black dot in RGB display
- 3) Multi-bright dot: Power on TFT and fluorescent tiny dot in black display(only visible in black display)

12.6.2.2 LCD appearance dot defect (defect category : MI.)

Na				spection c			Diatuma	Inspection	
No.	Item	Size		S<5"	5"≤S<10"	10"≤S<15"	Picture	method/tools	
		D≤0).15	Not count	Not count	D≤0.2mm			
		0.15<	D≤0.25	3	3	Not count	↓ b	Naked eyes /film card	
		0.25<	D≤0.30	1	2	0.2~0.35mm	→ a →		
12.6.2.2.1	Dot defect	0.30 <d≤0.35< td=""><td>0</td><td>1</td><td>Q'ty ≤ 4</td><td>11/12/1973</td><td>/magnifier</td></d≤0.35<>		0	1	Q'ty ≤ 4	11/12/1973	/magnifier	
	(black dot,		D≤0.50	0	0	1	D=(a+b)/2	, , , , , , , , , , , , , , , , , , ,	
	white dot)	D>0.5		0	0	0			
	Remark : D≤0.15mm, not count.Multi-dot as bulk is not ac Count dot quantity≤ 5 2 round dots or linear dots in 1 cm is judged as multi-dot.								
		Length (mm)	Width (mm)	S<5"	5"≤S<10"	10"≤S<15"			
		Not count	W≤0.03	Accepted	Accepted	Accepted			
	Line	L≤5	0.03≤W <0.05	3	3	Not count		Naked eyes /film card	
12.6.2.2.2	defect (visible	L≤5	0.05≤W <0.08	0	1	3) .	/magnifier	
	when power on)	L≤8	0.05≤W <0.08	0	0	1			
		L>8	W>0.08	0			•		
			•		•	pecial angle ag touched, no c			



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	Polarizer	Size(mm)	S<5"	5"≤S<10"	10"≤S<15"			
	convex-	D≤0.20	Not count	Not count	Not count			
	concave	0.20 <d≤0.5< td=""><td>2</td><td>2</td><td>3</td><td>. 80</td><td>Naked eyes</td><td></td></d≤0.5<>	2	2	3	. 80	Naked eyes	
12.6.2.2.3	dot defect,	0.50 <d≤0.8< td=""><td>0</td><td>1</td><td>3</td><td>\$ b</td><td>/film card</td><td></td></d≤0.8<>	0	1	3	\$ b	/film card	
	polarizer	0.8 <d≤1.5< td=""><td>0</td><td>0</td><td>1</td><td>◆ a →</td><td>/magnifier</td><td></td></d≤1.5<>	0	0	1	◆ a →	/magnifier	
	bubble defect	D>1.5mm	0	0	0	12 202 2000		

	defect		-				
12.6.3 Chippir	ng defect						
No.	Item		Accepte	d criterion(mm)		MA.	MI.
12.6.3.1	ITO conductive side	Х	1	≤1/8L	1		
		Υ	Y≤1/6W	1/6W <y≤1 4w<="" td=""><td>1/4W <y< td=""><td></td><td>$\sqrt{}$</td></y<></td></y≤1>	1/4W <y< td=""><td></td><td>$\sqrt{}$</td></y<>		$\sqrt{}$
	The state of the s	Accept	2	2	0		٧
	× ×						
	Corner chipping	Х	1	≤1/6L	1		V
	(ITO pins position)	Y	Y≤1/2W	1/2W <y≤w< td=""><td>W <y< td=""><td></td><td>٧</td></y<></td></y≤w<>	W <y< td=""><td></td><td>٧</td></y<>		٧
12.6.3.2		Accept	2	1	0		
	Z	Corner chipping occurred in sealed edge position as per 6.3.3; at the same time it should not enter into black border of the frame and the corner chipping effect the electric connection position perform as per 6.3.1.					
	Chipping in sealed area (outside chipping)	Х	1	≤1/8L	1		
	area (outside cripping)	Y(outside chipping)	Not enter into	Enter Y≤H	H <y< td=""><td></td><td></td></y<>		
		Y(inside chipping)	sealant	Enter Y≤1/2H	1/2H <y< td=""><td></td><td></td></y<>		
12.6.3.3	24	Z	≤T	≤1/2T	/		$\sqrt{}$
	1	Accept	2	1	0		
	Chipping in sealed area (inside chipping)	sealing are	ea are same osite of stag	er and outer chipping. When the chipping of the chipping of the chipping and ard in 6.3.1	ng occurred	MA.	
	Conductive side (back side chipping)	Х	/	≤1/6L	1		
40.00	y	Y	Y≤1/3W	1/3W <y≤2 3w<="" td=""><td>2/3W <y< td=""><td></td><td>$\sqrt{}$</td></y<></td></y≤2>	2/3W <y< td=""><td></td><td>$\sqrt{}$</td></y<>		$\sqrt{}$
12.6.3.4	Z	Accept	2	2	0		
	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Chipping into ITO side, refer to 6.3.1					



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	Protruding LCD poor cutting and LCD burrs	Х	/	≤1/8L	/		
12.6.3.5	Cutting and LOD build	Y	≤1/6W	1/6W <y≤1 5w<="" td=""><td>1/5W <y< td=""><td></td><td>V</td></y<></td></y≤1>	1/5W <y< td=""><td></td><td>V</td></y<>		V
		Z	1	/	1		V
		Accept	1	1	1		
		The outside drawing.	e protruding	control as per the t	olerance of	/ 1 lerance of the crack	
12.6.3.6	Crack	expand to	inside is NG,	ks without direction but to outside is O lamaged standard)	K		V

Remark:

X means the length of chipping;

Y means the width;

Z means the thickness;

W means the step width of the two glasses;

H means the distance from the glass edge to the sealant inner edge;

T means glass thickness.

12.6.4 Backlight components

No.	Item	Description	Accepted criterion	MA.	MI.
12.6.4.1	No backlight wrong Color	1	Rejected	V	
12.6.4.2	Color deviation	When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing.	Refer to sample and drawing		V
12.6.4.3	Brightness deviation	When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over ±40% than its typical value.	Refer to sample and drawing		√
12.6.4.4	Uneven brightness	Uneven on the same LCD and out of the specification of the drawing. The no specification evenness= (the max value-the min value)/ mean value< 70%.	Refer to sample and drawing		V
12.6.4.5	Spot/line/ scratch	When power on, it has dirty spot, scratches and so on spot and line defects.	Refer to 6.2.2		V

12.6.5 Metal frame (Metal Bezel)

No.	Item	Description	Accepted criterion	MA.	MI.
12.6.5.1	Material & surface treatment	Metal frame/surface treatment do not conform to the specifications.	Rejected	V	
12.6.5.2	Tab twist Unconformity /Tab not twisted	Wrong twist method or direction and twist tabs are not twisted as required.	Rejected	V	



12.6.5.3	Bezel paint loss	1.Front surface : Paint peel off and scratch to the		1
12.6.5.4	Bezel scratch	bottom Dot:D≤0.5mm, exceeds 3;		V
12.6.5.5	Painting peel off, discoloration, dent, and scratch	Line:L≤3.0mm,W≤0.05mm exceeds 2; 2.Front dent, air bubble and side with paint peeling off scratch to the bottom Dot: D≤1.0mm, exceeds 3; Line:L≤3.0mm,W≤0.05mm, exceeds 2;	Rejected	√
12.6.5.6	Burr	Burr(s) on metal bezel is so long as to get into viewing area.	Rejected	√

12.6.6 FPC

12.6.6 FPC No .	Item	Description Accepted criterion		MA.	MI.
12.6.6.1	Model &P/N	Material model & P/N Material model & P/N Keep the same with drawing and technical requirement		V	
12.6.6.2	Dimension/ position	Dimension in drawing spec H Remark: H=ITO pin length f=FPC width W=ITO pin width	f≤1/3w, h ≤1/3H, dimension in drawing spec-> OK Conducive material and ITO/PDA connective area must over than 1/2. Entire dimension must be in spec tolerance.		√
12.6.6.3	FPC appearance	Hot pressing material get broken, folding line open; FPC line is OK- > Accepted broken ,scratch ,foreign material which cause line short Broken length<2mm; FPC line is OK- > Accepted Crack and line broken->Rejected			√
12.6.6.4	FPC burr	Burr near FPC edge area When cover line and burr length ≤1.0mm->Accepted			V
12.6.6.5	FPC falling off	FPC bonding area falling off; silica gel breaking	Rejected		$\sqrt{}$
11.6.6.6	Sealant missing ITO line	Sealant is not covered all ITO line	Rejected	V	
12.6.6.7	Missing sealant	No sealant	Rejected	√	
12.6.6.8	Sealant	Sealant height ->product total height	Rejected	√	



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No.	Item	Description Accepted criterion		MA.	MI.
12.6.7.1	Soldering bridge	Solder between adjacent pads and components	Rejected		V
12.6.7.2	Solder ball/splash	Solder ball/tin dross causing short circuit at the solder point. There are active solder ball and splash.			V
12.6.7.3	Soldering excursion	Soldering slant > 1/3 soldering pad 「學盘寬度」 「學養寬度」	Rejected		√
12.6.7.4	Component wrong	Component on PCB differs with drawing: wrong one, extra one,lack one,opposite polarity	Rejected	V	
	attaching	JUMP short circuit on PCB: extra soldering ,lack soldering.	Rejected	\checkmark	
12.6.7.5	Component falling off	Soldering but component is missing	Rejected	√	
11.6.7.6	Wrong component	Component model/spec differs from product specification Rejected		√	

No.	Item	Description	Accepted criterion	MA.	MI.
12.6.8.1	Dimension	According to drawing	Accepted	√	
12.6.8.2	Surface stain	Defect mark or label are not removed residual glue, and finger print,etc;	Rejected		V
12.6.8.3	Assembly foreign material	Dot/linear stain after assembly backlight and diffuse film TP assembly fogy stain	Invisible when power on->OK Refer to 6.2.2 dot/line spec		√
12.6.8.4	Mixture	Different model product in the same shipment	Rejected	\checkmark	
12.6.8.5	Product mark	Missing, unclear, incorrect, or misplaced part	Rejected		V
12.6.8.6	Componen t mark	Silk screen mark clear, resistance measured value in spec	Accepted (Refer to customer special requirement)		√
12.6.8.7	Newton's rings	Area<1/6 screen area quantity≤1	Accepted		√
12.6.8.8	Mura	1.In black display ND 3% invisible ->OK; visible->NG 2.Naked eyes inspection RGB display invisible Black display, area<1/4 screen area	Refer to limited sample		√



12.6.8.9	Light leak	1.LCD edge(near backlight) shadow by LCD lamps irregular illuminate 2.Judge in black/white/gray display (slight leaky is yellowish, greenish, blueish ->NG); Tape 浮起漏光	Refer to limited sample	√
12.6.8.10	Polarizer	1.Polarizer slant.Cover VA and not over LCD edge 2.No unmovable stain or finger print in polarizer VA 3.Bubble/warped but not enter VA	Accepted	√
12.6.8.11	TP defect	1.TP crack 2.TP stain(fogy& unremovable) 3.TP glue overflow to VA	Rejected	√

Remark:

Anything which is not clearly defined in $6.5\sim6.8$ should refer to IPC-A-610E.Consumer Electronics, Non-consumer Electronics refer to I grade and Industrial, Automobile refer to II grade.

12.7 Others

Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.



13. HANDLING PRECAUTIONS

13.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

13.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly:

- .lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- .Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated :

- Soldering flux
- •.Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

13.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

13.4 Packing

Module employ LCD elements and must be treated as such.

- Avoid intense shock and falls from a height.
- •. To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

13.5 Caution for operation

- •.It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- •.An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- •.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- •.If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit
- •. Usage under the maximum operating temperature, 50%Rh or less is required.
- •. When fixed patterns are displayed for a long time, remnant image is likely to occur.

13.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
- •. Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.
- •.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- .Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.



13.7 Safety

- •.It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- •. When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

14. PRECAUTION FOR USE

- **14.1** A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.
- **14.2** On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.
- •. When a question is arisen in this specification.
- •. When a new problem is arisen which is not specified in this specifications.
- •. When an inspection specifications change or operating condition change in customer is reported to AVD, and some problem is arisen in this specification due to the change.
- •. When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

15. PACKING SPECIFICATION

Please consult our technical department for detail information.